

July 2006

FFB20UP30DN

Features

- Ultrafast Recovery, t_{rr} = 45 ns (@ I_F = 10 A)
- Max Forward Voltage, $V_F = 1.3 \text{ V } (\text{@ } T_C = 25^{\circ}\text{C})$
- Reverse Voltage : V_{RRM} = 300 V
- · Avalanche Energy Rated
- RoHS Compliant

Applications

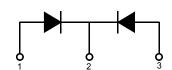
- · General Purpose
- · Switching Mode Power Supply
- Free-Wheeling Diode for Motor Application
- · Power Switching Circuits

20 A, 300 V, Ultrafast Dual Diode

The FFB20UP30DN is an ultrafast dual diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applicationa as welder and UPS application.



1.Anode 2.Cathode 3.Anode



1. Anode 2. Cathode 3. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{RRM}	Peak Repetitive Reverse Voltage	300	V
V _{RWM}	Working Peak Reverse Voltage 300		V
V _R	DC Blocking Voltage	300	V
I _{F(AV)}	Average Rectified Forward Current Rating for each diode I _{F(AN)} /2 @ T _C = 130°C	20	Α
I _{FSM}	Non-repetitive Peak Surge Current 180 60Hz Single Half-Sine Wave		А
T _J , T _{STG}	Operating Junction and Storage Temperature - 65 to +150		°C

Thermal Characteristics

Symbol	Parameter	Max	Unit	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.0	°C/W	

Package Marking and Ordering Information

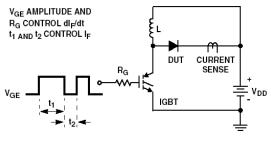
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F20UP30DN FFB20UP30DNTM		TO-263AB/D2-PAK	13" Dia	=	800

Electrical Characteristics (per diode) T_C = 25°C unless otherwise noted

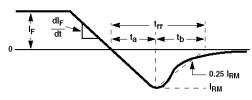
Symbol	Parameter		Min.	Тур.	Max.	Unit
V _F *	I _F = 10 A I _F = 10 A	T _C = 25 °C T _C = 150 °C	-	-	1.3 1.2	V V
I _R *	V _R = 300 V V _R = 300 V	T _C = 25 °C T _C = 150 °C	-	-	1 500	μ Α μ Α
T _{rr}	I_F =0.5 A, I_{rr} =1 A, V_{CC} = 30 V I_F =1 A, di/dt = 100 A/ μ s, V_{CC} = 30 V I_F =10 A, di/dt = 200 A/ μ s, V_{CC} = 195 V	$T_{C} = 25 °C$ $T_{C} = 25 °C$ $T_{C} = 25 °C$	- - -	- - -	30 35 45	ns ns ns
t _a t _b Q _{rr}	$I_F = 10A$, di/dt = 200A/ μ s, $V_{CC} = 195V$	$T_{C} = 25 °C$ $T_{C} = 25 °C$ $T_{C} = 25 °C$	- - -	11 13 20	- - -	ns ns nC
W _{AVL}	Avalanche Energy (L = 20 mH)		20	-	-	mJ

^{*}Pulse Test: Pulse Width=300 μs, Duty Cycle=2%

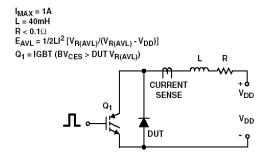
Test Circuit and Waveforms



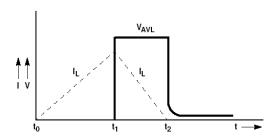




t_{rr} WAVEFORMS AND DEFINITIONS



AVALANCHE ENERGY TEST CIRCUIT



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Typical Performance Characteristics Figure 1. Typical Forward Voltage Drop

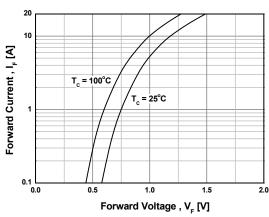


Figure 2. Typical Reverse Current

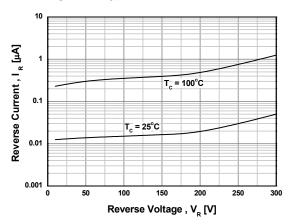


Figure 3. Typical Junction Capacitance

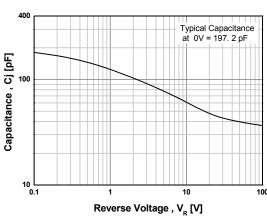


Figure 4. Typical Reverse Recovery Time

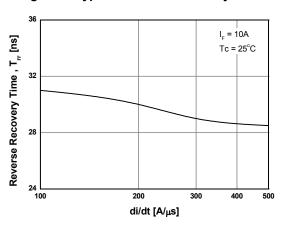


Figure 5. Typical Reverse Recovery Current

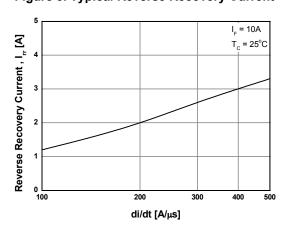
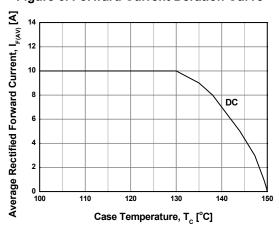
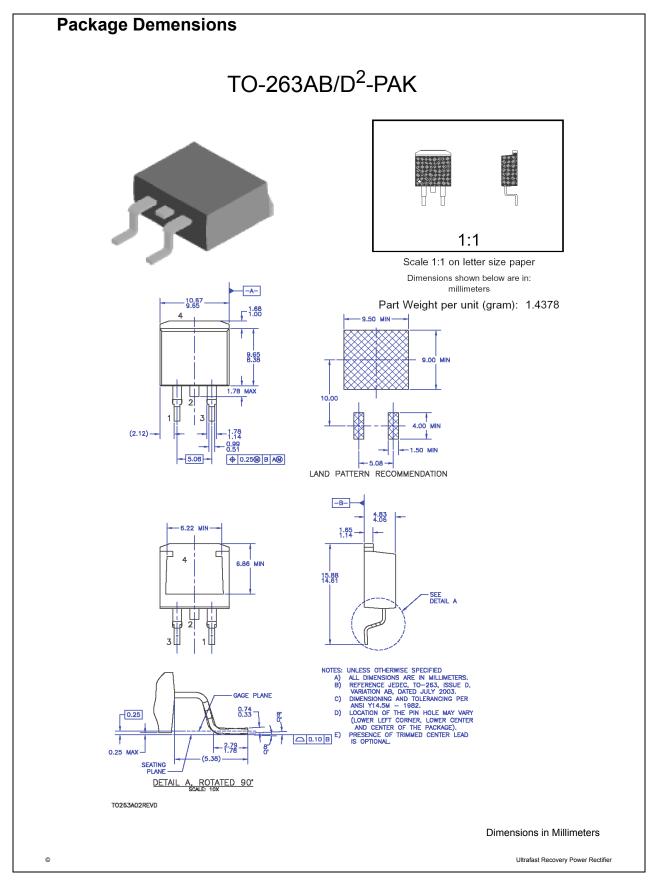


Figure 6. Forward Current Deration Curve





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